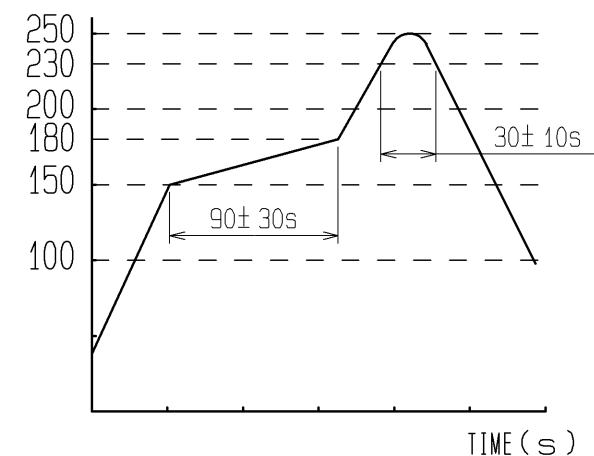


ELV, RoHS COMPLIANT

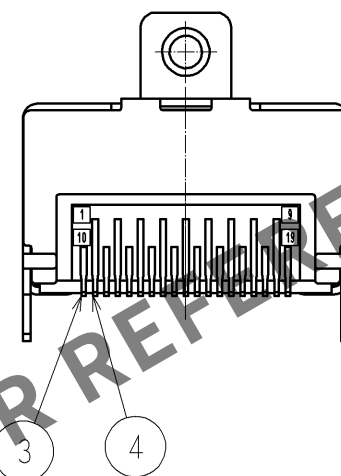
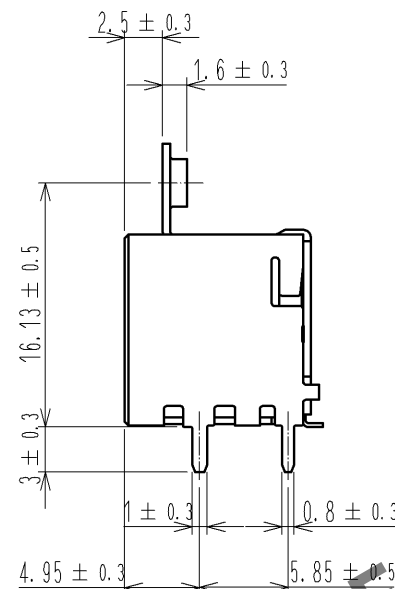
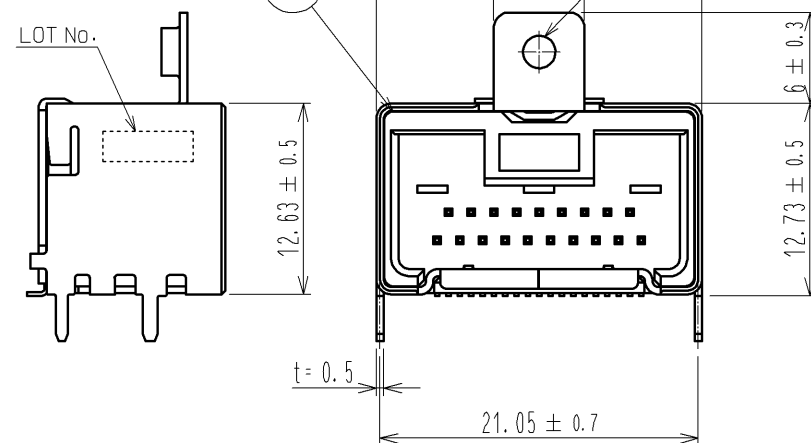
NOTES

1. RECOMMENDED REFLOW PROFILE (SEE RIGHT GRAPH)
CYCLE TIME: UP TO 2 CYCLES OF REFLOW SOLDERING ARE POSSIBLE
UNDER THE CONDITIONS, PROVIDED THAT THERE IS
A RETURN TO NORMAL TEMPERATURE BETWEEN THE FIRST
AND SECOND CYCLE.
PEAK TEMPERATURE: 250°C
230°C MIN. FOR 20 TO 40 SECONDS.
PREHEATING AREA 150~180°C FOR 60 TO 120 SECONDS.
2. HAND SOLDERING: 280-300°C, 2S MAX.
3. CONTACT COPLANARITY: 0.1mm MAX.
4. RECOMMENDED THICKNESS OF PCB: 1.6mm
5. RECOMMENDED THICKNESS OF SOLDERING PASTE: 0.15mm

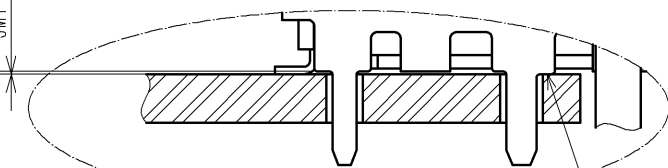
TEMP. (°C)



LOT No.

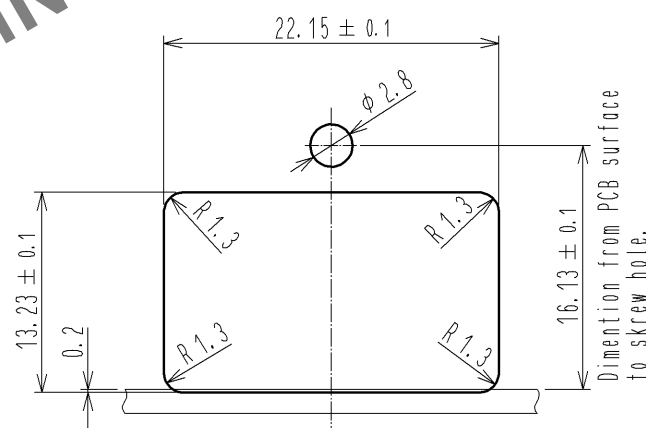
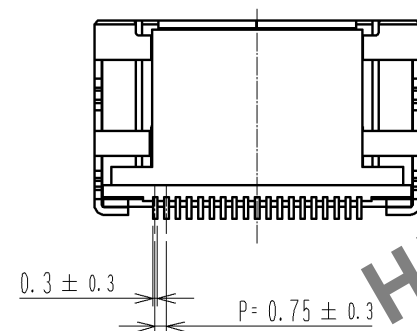


0.1 +0.1
-0.05
SMT = 0 ± 0.1

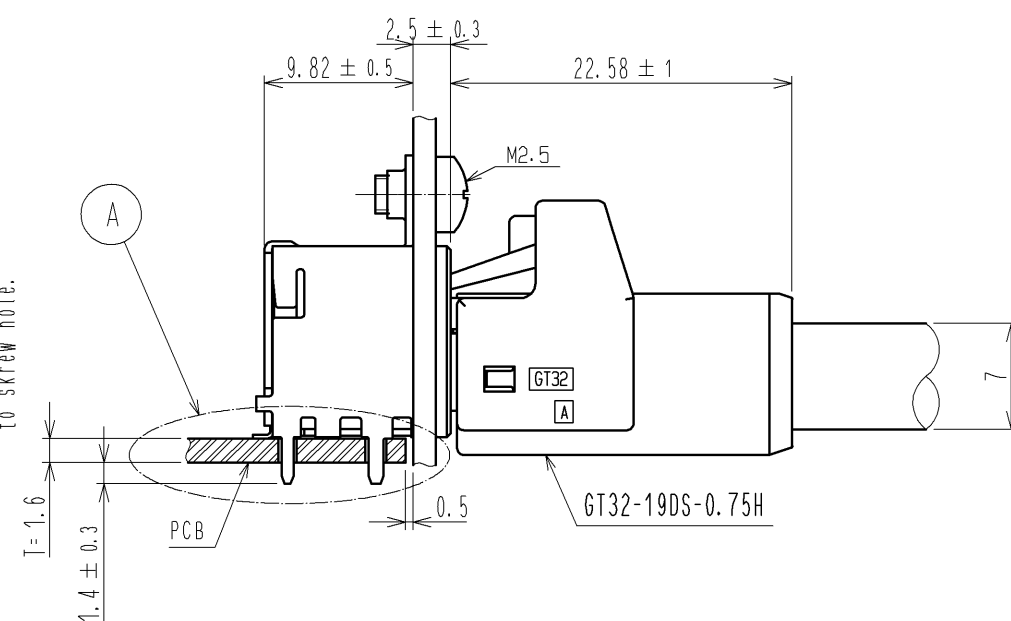


Soldering Standard Position

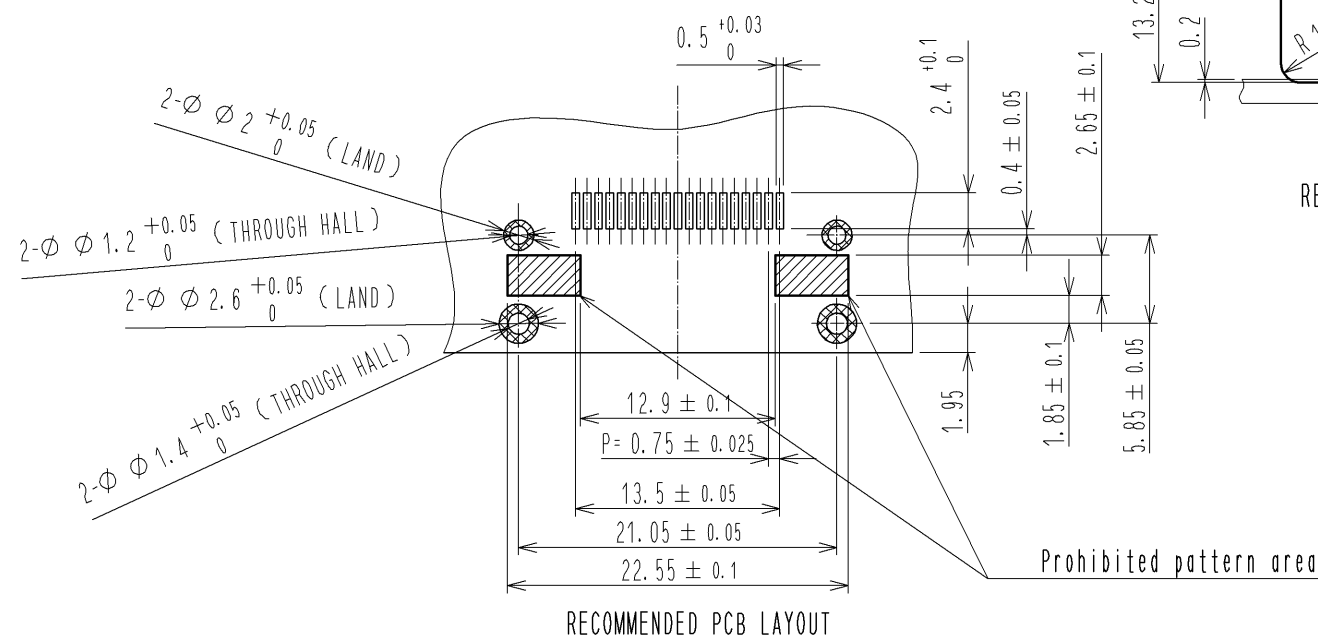
A (4:1)



RECOMMENDED PANNEL LAYOUT



MATED CONECTERS



RECOMMENDED PCB LAYOUT

2	PA	GRAY	4	BRASS	TIN PLATED
1	COPPER ALLOY	TIN PLATED	3	BRASS	TIN PLATED
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 1	DESCRIPTION OF REVISIONS DIS-T-004064	DESIGNED NK. IKUTA
		APPROVED : AR. SHIRAI	12. 03. 02	DRAWING NO.	EDC3-168826-00
		CHECKED : NH. NAKATA	12. 03. 01	PART NO.	GT32-19DP-0.75H
		DESIGNED : MH. SHOUJI	12. 02. 20	CODE NO.	CL782-0009-3-00
		DRAWN : MH. SHOUJI	12. 02. 20		
		DATE	14. 09. 19		

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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

PACKAGE SPECIFICATIONS

- ①. Place the connectors into the tray. (Cf. Figure of tray shape)
QTY per tray: 77pcs
- ②. Put the tray for six steps in turn and wind up a PP band.
Top(the sixth step) is an empty tray.
- ③. Put it in a cardboard box (W=267 H=126 D=365)
QTY per cardboard: 385 pcs

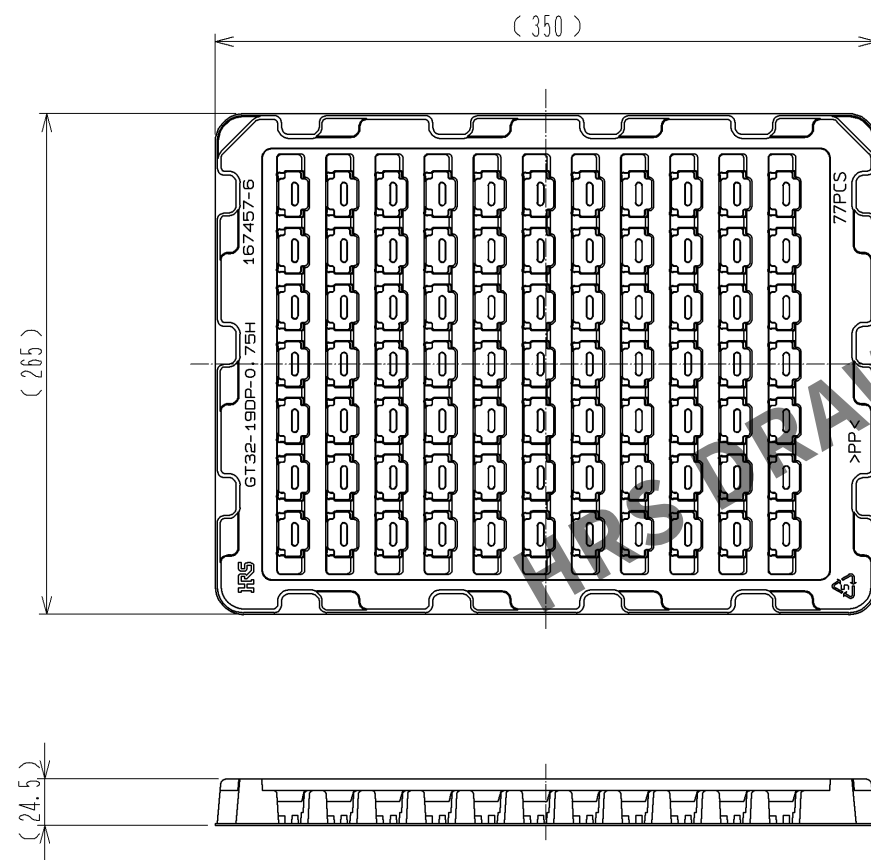


Figure of tray shape

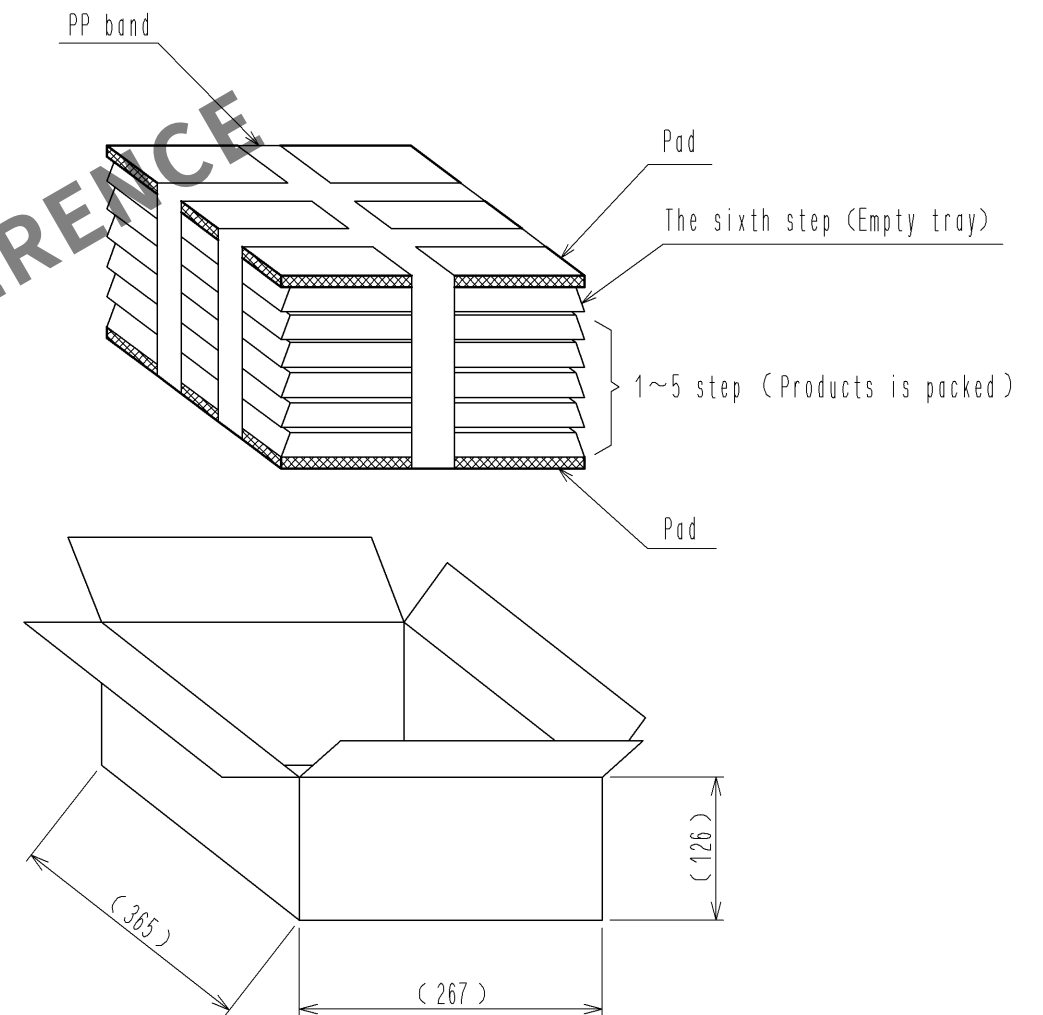


Figure of packing



図番:	EDC3-168826-00
製品名:	GT32-19DP-0.75H
製品コード	CL782-0009-3-00